Hydrogen-terminated Detonation Nanodiamond: Impedance Spectroscopy and Thermal Stability Studies

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ABSTRACT

In this paper, we investigated the effect of hydrogen termination on the electrical properties and impedance spectra of detonation nanodiamond. The impedance spectra revealed that the hydrogen-termination process increases the electrical conductivity by four orders of magnitude at room temperature. An equivalent circuit has been proposed to correlate with the conduction mechanism. Arrhenius plot showed that there were two different activation energy levels located at 0.089 eV and 0.63 eV between 50°C and 400°C. The possible physical mechanism corresponding to these activation energy levels has been discussed. Hydrogen-terminated detonation nanodiamond has been further annealed at different temperatures prior to FTIR and XPS measurements in order to understand their thermal stability. The results demonstrated that the surface oxidization occurred between 100°C and 150°C. However, the C-H bonds could partially survive when the temperature reaches 400°C in air. © 2012 American Institute of Physics.

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I. INTRODUCTION

Detonation-synthesized nanodiamond (DND) is an attractive class of diamond material, which has great potential to be used for a wide range of applications. DND powder has been widely used as a biocompatible material for *in-vivo* drug delivery carriers, electrochemical catalysts, fluorescent biomedical markers, purification of proteins, and bacterial binding biosensors, *et al.* More recently, our research has found that nanodiamond additives can help loosen crystallized fat from surfaces at low temperature, which transforms the ability of washing powders to remove dirt in eco-friendly low temperature laundry cycles. This will have the potential to bring huge energy savings in an essential, everyday domestic wash. Understanding the surface properties of DND powders and the ability to manipulate the surface physical and chemical properties of DND particles are crucial for specific applications discussed above.

Each individual DND particle has a “sootlike” structure outside the core, which is composed of free graphitic layers (or other *sp*²/*sp*³ non-diamond species), metallic residues, the balance oxygen being and explosives from the detonation process. Hydrogen- and oxygen-termination processes are common methods for functionalizing the DND’s surface. It is well established that hydrogen-termination of two-dimensional (2D) diamond thin films can lead to *p*-type electrical conduction and hydrophobic surfaces, whilst the oxygen termination will form hydrophilic surfaces. Since the DND has an average grain size in the nano-meter range, the hydrogen termination on the surfaces of DND particles might present some different properties when compared with 2D thin films. Therefore studies of DND deaggregation, modification, surface characterization and thermal stability have attracted significant interest from research community. Early reports of FTIR, NMR and XRD of DND particles revealed that the surface structures contained various non-diamond species (e.g. C-C,
C=C, C-H, C-O, C=O) as well as other functional groups. Yeganeh and Zeppilli et al. studied thermal annealing effect using photoemission spectroscopy (PES) and XPS. Xie et al. investigated the graphitization of nanodiamond surface. Jackman’s team has reported the impedance spectroscopy (IS) data on both aggregated DNDs in the as-received condition and monodispersed DNDs. However, the electrical properties of surface-modified DNDs have not been specifically investigated due to the difficulties in measurements and instrumentation. We have recently designed a novel testing system for impedance measurement of particles and powders. This testing system will be used here to collect more accurate data and to characterize the electrical properties of DNDs.

In this paper, untreated DND samples and hydrogen-terminated DND (H-DND) samples were used to perform spectroscopic impedance studies. In order to understand the thermal stability of these samples, annealing treatment has been carried out on H-DND at different heating temperatures ranging from 50°C to 400°C. FTIR and XPS results on these annealed samples have provided an insight into the evolution of the physical and chemical properties of the H-DND.

II. EXPERIMENTAL METHODOLOGY

‘As-received’ state DND powders (SIGMA-Aldrich Corp., average grain size: 4~6 nm) have been used throughout this study. A scanning electron microscopy image of a typical particle is shown in Fig 1. It can be seen that extremely small nanometer-scale crystals aggregated and form grain size of 50-150 nm, which in turn make up the ~2 μm particles.

The H-termination process was carried out using ASTeX5010 (Seki Technotron Corp., 2.45 GHz, 1.5 kW) microwave plasma enhanced chemical vapor deposition (MPECVD) system. A custom-designed molybdenum holder was placed inside the chamber to constrain the DND powders during the plasma process. The optimized microwave power was 900 W at
a pressure of 50 Torr with a hydrogen gas flow rate of 200 s.c.c.m. The duration of H-termination treatment was fixed for 10 minutes and the temperature was set at 850°C, which was recorded by an infrared thermometer (model: Williamson Pro 92-40-C, range: 475-1475°C). At the end of the plasma process, the samples were maintained inside the chamber until cooled to room temperature. After cooling, DND samples were removed and a fixed amount of the DND samples were loaded into the testing cell for measurement.

It is impractical to carry out the IS measurement on a single particle, hence a custom-designed measurement system for IS on DND powder has been introduced as shown in Fig. 2. The testing cell includes two copper plates, one of which has been carefully polished and then electroplated with high-purity nickel, which served as the bottom electrode. A hollow ceramic washer has been attached to the copper plate with high-temperature silver paste. Heating to 150°C in air cures the paste thus ensuring the washer has been tightly attached onto the bottom electrode, which serves as the sample container. A stainless steel bolt serves as the top electrode and another smaller copper plate holds the top electrode with two ceramic screws, which have been fixed onto the copper plate. The ceramic washer and the screws isolate the top electrode electrically from the lower one. Two metal springs have been fitted between the top and bottom copper plates to provide a relative constant force to the DND powders. This pressure generated from these springs is particularly important in measuring the porous materials/powders as the force resulted from the springs will influence the porosity/density of DND and consequently impact on the electrical response. The overall temperature error during the measurement is ± 2°C.

The IS impedance measurement was carried out in air at elevated temperatures from 50°C to 400°C using an Autolab PGSTAT 302N electrochemical system (Windsor Scientific Ltd) connected to the testing cell. The temperature range was limited to a maximum of 400°C, as the DND particles experience a catastrophic weight loss at temperatures above 400°C. The IS measurement was performed at elevated temperatures from 50°C to 400°C using an Autolab PGSTAT 302N electrochemical system (Windsor Scientific Ltd) connected to the testing cell. The temperature range was limited to a maximum of 400°C, as the DND particles experience a catastrophic weight loss at temperatures above 400°C.
The IS was performed over a frequency ranging from 0.1 Hz to 10 MHz with a potential bias of 0.35 V.

ESCALAB 250 X-ray Photoelectron Spectrometer (Thermo Corp.) with monochromatized Al Kα (1486.5 eV) X-ray source was employed to analyze the surface bonding states of the DND powders with a base pressure of $5 \times 10^{-10}$ mbar in the analysis chamber and a pass energy of 20 eV. The DND powders were attached on the stage by a double-sided conductive carbon paste. The infrared spectra were collected from Thermo IR 200 FTIR Spectrometer using KBr pellets. The KBr pellets were prepared by mixing a 25 mg DND sample with 250 mg potassium bromide (SIGMA-Aldrich Corp.). The pellets were pressed and placed into a desiccator with silica gel to remove the absorbed water on them. For FTIR and XPS measurements, all the H-DND samples were annealed in air at different temperatures from 50°C to 400°C.

### III. RESULTS AND ANALYSIS

#### A. Impedance spectroscopy

Impedance spectroscopy (IS) is a powerful tool for investigating the electric and dielectric behavior of ionic, electronic or mixed conductor ceramic.\(^{17}\) It has been successfully applied in characterizing the electrical properties of grain interiors as well as the grain boundaries properties of polycrystalline, nanocrystalline diamond, δ-doped diamond and monolayer nanodiamond.\(^{14,18-21}\) In essence, the IS technique involves the measurement of real and imaginary parts of the complex impedance as a function of frequency. The impedance can be expressed as a complex value as

$$Z(\omega) = Z' + jZ''$$

$$Z' = \sum_{n=1}^{N} \frac{n\xi}{\omega^2 \xi^2 - \frac{1}{\tau}}$$  (2)
where \( Z(\omega) \) is the complex ac impedance as a function of angular frequency; \( \omega \) is angular frequency; \( Z' \) is the real part of impedance, referring to the resistive contribution from the measured impedance; and \( Z'' \) is the imaginary part of impedance, representing the capacitive contribution. The variable \( n \) can take values between 1 and 3, corresponding to the different types of conduction path. The real part of impedance versus the imaginary part can be plotted in one figure as a function of frequency, which forms a so-called Cole-Cole plot. The Cole-Cole plot can be fitted with an equivalent circuit from which the conduction mechanism can be deduced.\(^{18-20}\)

Impedance spectroscopy results of untreated DND samples and H-DND samples are shown in Fig. 3. Each measurement was taken by using the same amount of nanodiamond and presented in the format of Cole-Cole plot. The Cole-Cole plot of untreated nanodiamond is shown in Fig. 3 (a), which exhibits a near-perfect semicircle. The diameter of the fitted semicircle that is intercepted on the \( Z' \) axis indicates the real part of the impedance, i.e. resistance. The single semicircle indicates that only one primary mechanism exists for the conduction within the untreated DND sample. In order to analyze the impedance data further, a single resistor-capacitor (RC) parallel \((R_p/C_p)\) equivalent circuit can be used to simulate the electrical properties of untreated DNDs as shown in Fig. 4 (a). The fitting procedure used here is the same as the one described by Kleitz \textit{et al.}\(^{22}\) Here, the RC parallel circuit can be used to characterize the impedance contributed from the stacked particles. The resistance \((R_p)\) of the sample was calculated around \(7 \times 10^9\ \Omega\) by fitting the arc with this equivalent circuit.

The Cole-Cole plot of H-DND sample at room temperature is shown on Fig. 3 (b), which consists of a semicircle at higher frequencies and a straight line at low frequencies. The diameter of the fitted semicircle that is intercepted on the \( Z' \) axis, indicates the resistance of H-DND sample is around \(2.46 \times 10^5\ \Omega\), which is four orders of magnitude less than untreated
DND samples. Note that the low-frequency spectra of H-terminated DND forms a straight line at a 45° angle to both $Z'$ and $Z''$ axis. This phenomenon suggests that the corresponding equivalent circuit may consist of a Warburg diffusion component (see Fig. 4 (b)). The complex Warburg impedance $Z_w$ is composed by a constant phase element (CPE), which can be expressed as:

$$Z_{we} = Z(j\omega)^{-\sigma} = Z(\omega)^{-\sigma}[\cos(-\sigma \frac{\pi}{2}) + j \sin(-\sigma \frac{\pi}{2})]$$  (4)

where $Z$ represents the impedance in Eq. (1) and $\omega$ is the angular frequency. The exponent $\sigma$ is a frequency-dependent correction factor with the value between 0 and 1. When $\sigma$ is 1, the CPE component is a pure capacitor and 0 for a pure resistor. As the exponent $\sigma$ equals to 1/2, Eq. (4) can be expressed as:

$$Z_{w} = (\frac{Z}{\sqrt{j\omega}})(1 - j)$$  (5)

which was described as Warburg diffusion element. The Warburg diffusion element can be used to characterize infinite-length approximation of DND particles stacked together and mutual interaction after hydrogen passivation process. Preliminary analysis suggests that the presence of the Warburg element can be attributed to the water absorption on the surface and the colloidal properties of the DND powder. Besides, the formation of C-H bonds on DND particles’ shell enhances their conductivity and possibly enables an infinite-length approximation of their electrical properties. Similar results have been reported on the electrochemical properties of DND fabricated electrodes by Zang et al. The author attributed the low frequency linear portion to the inhomogeneous porous structure, which leads to a non-ideal capacitive element.

When the measurement temperature increases to 50°C, the impedance data of H-DND samples show a similar trend as those measured at room temperature (Fig. 3 (c)). The resistance is increased to ~5.2 MΩ (at 50°C). Fig 3. (d) shows the impedance spectra of H-DND at 100°C. At this temperature, the Warburg effect has become negligible and overall
resistance has increased with increasing temperature. This observed phenomenon could be explained by the fact that the absorbed water evaporates from the DND particles surface when the samples being heated up to 100°C in air.\textsuperscript{25,26} Impedance spectra of H-DND samples at 150°C, 200°C and 250°C are shown in Fig. 3 (d) and (e). In these figures, the Warburg effect completely disappears at these temperatures. $R_p$ increased to 0.15 GΩ, 1.84 GΩ and 2.22 GΩ at temperature measured at 150°C, 200°C and 250°C, respectively. At 250°C, the sample showed a maximum resistance value, which is four orders magnitude higher than the H-DND sample measured at room temperature. The increase in the resistance at the temperature range from 150°C to 250°C could be explained as the incorporation of oxygen onto the surface of the DND powders. Further evidence will be provided via XPS and FTIR measurements in Sec. III. With temperature increasing to 300°C and to 350°C, the semicircle starts to shrink. The resistance decreases from 2.22 GΩ at 250°C to 0.834 GΩ and 0.246 GΩ, respectively. The drop in the resistance is probably due to thermal activation of non-diamond phase impurities on the DND particles and will be discussed in Sec. IV. A. Finally, when temperature increases to 400°C, the resistance increases again to ~0.8 GΩ, as shown in Fig. 3 (f). It is likely to be due to the oxidation of DND surfaces.\textsuperscript{27} At this temperature, the Warburg effect appeared again as it was in low-frequency range, which suggested to be associated with an increase in the surface homogeneity on the DND particles.\textsuperscript{28} The resistance error results from the following two factors: Autolab equipment system error (± 0.2%) and numerical fitting error (± 5%).

\textbf{B. Arrhenius relationship}

In Fig. 5, the Arrhenius relationship was plotted by $R_p$ versus 1000/T at temperatures ranging from room temperature to 400°C. First of all, the resistance $R_p$ increases with the increasing temperature up to 150°C. At this stage, the primary electrical conduction
mechanism is attributed to the surface absorbed water, which provides a conduction path between the aggregated nanodiamond particles.\textsuperscript{13,14} Secondly, for the temperatures ranging from 170\degree C to 225\degree C, the resistance $R_p$ decreases with increasing temperature. The Arrhenius relationship can be expressed by Eq. (6) and (7):

$$R = Ae^{-\frac{E_{\text{act}}}{kT}}$$

$$\ln(R) = -E_{\text{act}} \left( \frac{1}{T} \right) \left( \frac{1}{\text{eV/}k} \right) + \ln(A)$$

where $E_{\text{act}}$ represents the activation energy of a certain kind of semiconductor and $k$ is the Boltzmann’s constant. From Eq. (5), an activation energy of $E_{\text{act}1}$=0.089 eV can be calculated covering the data between 170\degree C to 225\degree C, which could be associated with the thermal activation from the hydrogen-termination on H-DND. Finally, for the temperatures ranging from 250\degree C to 350\degree C, the resistance $R_p$ decreases with increasing temperature. From Eq. (7), an activation energy of 0.63 eV can be allocated to these data. Detailed discussion will be given in Sec. 4 A.

C. FTIR spectroscopy

In order to understand the thermal stability of the nanodiamond powder, we have carried out thermal annealing experiments on H-DND, at temperatures ranging from 50\degree C to 400\degree C. Fig. 6. Shows the FTIR results of untreated DND samples, and H-DND samples with post annealing. All the FTIR spectrum displayed a significant peak located at 1630 cm\(^{-1}\) ($\delta_{\text{OH}}$ bend mode), which were derived from the absorbed water on the surface.\textsuperscript{29,30} For the untreated DND powder spectra, one low intensity peak located at 619 cm\(^{-1}\) was observed and disappeared after H-termination. This peak should be associated with the carbon amide bonds on the particles’ surface and it did not appear during the thermal treatment in air.\textsuperscript{9} The peak around 1126 cm\(^{-1}\) in untreated sample might be assigned as either the ether group ($v_{\text{C-O-C}}$) or the $\delta_{\text{OH}}$ vibration from water. Here, it is more likely to be associated with the water absorbed
on the surface of the DND powder rather than the ether group. Thus the surface chemical properties (such as hydrophilic or hydrophobic) would have an influence on the intensity of this peak. This peak at 1126 cm\(^{-1}\) became weakened after the H-termination, which could be explained by the fact that H-termination enhances the hydrophobic properties of the DND particles through the formation of C-H bonds on the surface.\(^{31}\) The peak around 1255 cm\(^{-1}\), which is linked with the C-O group, was not significant for the untreated sample but became dominant when the annealing temperature reached 150°C or above. This result suggests that the H-DND particles’ surface starts to oxidize in air at 150°C. The weak peak located at 1336 cm\(^{-1}\) proved the existence of the C-N bonds (cyclic carbon in cyclic lactams, -C=NH).\(^9\) This peak survived after H-termination treatment and then started broadening with the increasing annealing temperature. Eventually, it vanished at the 350°C or above. The peak located at 1731 cm\(^{-1}\) is due to the presence of the C=O bonds (carbonyl group), which was associated with ester or amide. This peak was observed in the untreated DND sample but disappeared after hydrogen plasma treatment. After annealing at 300°C or above, the peak at 1731 cm\(^{-1}\) reappeared which implied that the formation of the C=O bonds. After hydrogen plasma passivation, the H-DND exhibited surface modification with two broad peaks located at 2930 and 2960 cm\(^{-1}\), while the untreated sample did not. These two absorbance peaks correspond to alkyl \(sp^3\) C-H (-CH\(_3\)/-CH\(_2\)) bonds stretching vibration mode.\(^9\) Summarizing the FTIR results from untreated and H-DND samples, it can be concluded that the hydrogen-termination process functionalizes the surface of DND with C-H bonds and removes a certain percentage of carbon-oxygen compounds.

D. X-ray Photoelectron Spectroscopy

XPS technique has been applied to determine the relative composition of the DND samples. Survey spectra have been recorded for all the samples (untreated DND, H-DND,
and the thermally annealed H-DND powders) and subsequent curve fitting is shown in Fig. 7. The significant C1s peaks between 280.0 and 290.0 eV have been normalized in order to highlight the other impurity peaks. The minimal chromium impurities (Cr 2p1/2p3: 584.7/575.7 eV) can be derived from the post-synthesis using a Cr2O3/H2SO4 mixture to oxidize sp² carbon element. From the XPS analysis, there is no evidence that other metallic impurities are presented in the DND sample, which indicates the as-received samples should have been purified with acids mixture (e.g. hydrochloric acid/nitric acid mixture). The O1s line in the survey spectrum is located at 529.4 eV, which can be associated with the surface ether, hydroxyl and carbonyl bonds. The N1s spectrum includes two components with maximum at 400.8 eV and 397.8 eV. The N1s located at 400.8 eV is the evidence of interaction with oxygen and the other one represents nitrogen atoms incorporated in the nanodiamond core. For the untreated DND sample, impurities such as oxygen and nitrogen can be attributed to the reaction involving the detonation process, which contains oxygen-deficient trinitrotoluene (TNT) and hexogen composition. After hydrogen termination, the oxygen peak has significantly decreased, while the nitrogen and chromium peaks remain as before. The ratio of each composition on DND analyzed by XPS was listed in Table 2. The content of chromium for each sample was constant before/after H-termination treatment and during the annealing process. After hydrogen passivation, the oxygen concentration significantly decreased. When the annealing temperature reached 150°C or above, the oxygen percentage increased. Meanwhile, the nitrogen concentration slightly increased with increasing temperature from 50°C to 350°C. A detailed analysis has been discussed in Section IV.

IV. DISCUSSION
According to Eq. (3), when \( n=3 \), this equation indicates that there are three conduction mechanisms in the semiconductor material namely: electrode, grain interiors (GI) and grain boundaries (GB).\(^{17-19}\) It was already established in literature that the capacitance associated with grain boundary (\( C_{GB} \)) is 2-3 orders of magnitude higher than the capacitance associated with the grain interior (\( C_{GI} \)).\(^{19,22}\) The parameters \( R_p \) and \( C_p \) were extracted from the fitting equivalent circuit and shown in Table 1. The paralleled resistance \( R_p \) and capacitance \( C_p \) represent the intrinsic resistivity and the dielectric properties of the H-DND. \( R_p \) varied with the increasing temperature but the parallel capacitance \( C_p \) was constant at pico-farad (pF) level, which suggested \( C_p \) had little relationship with the surface modification and the thermal annealing process.

Comparing the IS response of the H-DND with the untreated DND sample, a Warburg component was found in the equivalent circuit in the hydrogen-terminated sample. Zang and Portet et al. proposed similar Warburg components, which were observed in electrochemical experiments on DND powder.\(^{25,38}\) The presence of the Warburg component can be explained by: (1) the porous structure and the surface roughness; (2) the infinite-element approximation of the material.\(^{24,25}\) Both of the proposed mechanisms are feasible in our case. At the temperature range below 100 °C, the aggregated DND can be considered as a porous material with a grain size in the order of micrometers (Fig. 1).\(^7\) On the other hand, the aggregated DND powder can be considered as a three-dimensional network of individual DND particles in the proposed equivalent circuit model, which is different from single/polycrystalline diamond film.\(^{25}\) Surface mutual interactions occur within the three-dimensional network, in association with the presence of C-H bonds after the hydrogen plasma treatment.

Chaudhary et al. reported a DND capacitance of ~10 pF at temperatures ranging from 23~150°C and attributed it to a grain boundary contribution.\(^{14}\) Bevilacqua et al. studied the impedance response of the untreated DND powder and concluded that a ‘grain-interior-like’
electrical conduction exists below 350°C. But it was switched to surface-interface conduction at higher temperature.\textsuperscript{13} In our IS measurement of H-DND, there was only single semicircle response observed while the temperature heating up, which indicated only one conduction mechanism occurred during the whole process (Fig. 3. a-f). The average grain size indicates that the effect of small-size and the large surface area-to-volume ratio may reduce the capacitance $C_p$, comparing with the capacitance calculated in single/poly-crystalline diamond films.\textsuperscript{17-20} The hydrogen-termination treatment enhanced the grain boundary conduction on the surface of the DND particles and grain interior effect from the core was undermined. Thus, the GB conduction in the IS plot dominated, whilst little evidence for GI conduction was found.\textsuperscript{39} Hence, we associated that the capacitance with the grain boundaries conduction contribution for H-DND.

During the course of the increasing temperature, two activation energy levels, $E_{\text{act1}}$ and $E_{\text{act2}}$, can be calculated from the Arrhenius plot, which suggested two different conduction mechanisms. $E_{\text{act1}}$ is calculated to be 0.089 eV over the temperature range between 170°C and 225°C. $R_p$ slightly decreases with increasing temperature. I believe that $E_{\text{act1}}$ is likely to be associated with hydrogen termination. It is known that the hydrogen-termination of diamond thin film can improve the surface conduction and create a negative-electron-affinity (NEA) surface.\textsuperscript{40} Landstrass \textit{et al.} proposed that the conduction might be caused by the movements of hydrogen and defects from nonactive sites during the annealing process.\textsuperscript{41} Botev \textit{et al.} presented an activation energy of 0.1 eV from undoped diamond film by charged-based deep-level transient spectroscopy (Q-DLTS) method.\textsuperscript{42} Mori \textit{et al.} assumed an existence of surface conductive layer caused by chemical absorption or oxidization.\textsuperscript{43} Therefore, we suggest that $E_{\text{act1}}$ is originated from surface hydrogen-termination of DNDs.

At temperatures from 250°C to 350°C, the other activation Energy $E_{\text{act2}}$ is calculated to be 0.63 eV. This level of activation is close to the value of $n$-type phosphorous doping in
diamond film. However, further XPS analysis showed that there was no significant trace of phosphorous elements (see Sec. III). Various explanations of this activation energy level have been proposed by other researchers. Ye et al. studied the dielectric properties of nanocrystalline diamond film and found an activation energies at 0.67 eV. The author assumed that the phenomenon might be the change of the crystal field caused by thermal expansion, or by surface bond concentration of nanosized particles. Werner and Huang et al. have assigned this effect to the space charge limited current and Poole-Frenkel mechanism for the non-linear electrical response. Here, we associated the activation energy with the crystalline defects, or the surface $sp^2$ carbon phase (non-diamond materials), which had been reported in undoped diamond film. For all the Cole-Cole plots, there is only one semicircular response indicating only one conduction mechanism existing for the DND powder. If the chromium impurity contributes to the electrical conduction, there should be a secondary semicircle response in the Cole-Cole plot. In addition, the small concentration of Cr (0.3%) made it unlikely to form a continuous conduction path within the DND powder. Thus the metallic impurities (Cr) do not contribute to the electrical conduction.

The FTIR and XPS study focused on the thermal stability of the H-DND. In comparison, the CVD diamond film can be oxidized while heating in an oxygen atmosphere over 500°C. Previous reports on diamond powder with a micrometer-range grain size indicated the oxidization temperature was 477°C. Zou et al. found that 5-nm DND started to incorporate with the oxygen in air at the 228°C by thermogravimetric analysis (TGA) and completely oxidized over ~600°C. Based on the FTIR and XPS analysis of DND powder in our research, it is found that oxygen has been incorporated into the DND powder between 100°C and 150°C. At this temperature range, C-O bonds formed. C=O bonds appeared at the annealing temperature greater than 300°C and it also shows a trace of –COOH. Nitrogen can be incorporated into DND powders: (1) during the detonation process, and (2) via the surface
cyclic carbon lactams (C=NH). Carbon lactams can be ignored when the temperature is greater than 350°C. As the annealing temperature increased over 400°C, the homogeneity of DND powder was enhanced. The FTIR results also revealed that the C-H bonds could survive in the environment temperature as high as 400°C after hydrogen termination process.

V. CONCLUSION

In this paper, the electrical conduction mechanism of H-DND powder was analyzed by impedance spectroscopy and supported by FTIR, as well as XPS analysis. A custom-designed cell was utilized to measure the real-time electrical properties of the H-DND powder at different temperature. The results proved that hydrogen-termination treatment enhanced the electrical conduction and the resistivity reduced four orders of magnitude. The equivalent circuit extracted from the Cole-Cole plot contained a Warburg element, which demonstrated that the H-termination served as a link between the H-DND particles. It also suggests that the main conduction mechanism is on the grain boundary of the H-DND. Arrhenius plot reveals that there are two main conduction principles corresponding to two different activation energy levels, which can be associated to the hydrogen-termination and surface defects outside the DND particles, respectively. As the annealing temperature increased up to 150°C, the surface oxidization occurred and formed C-O bonds. The carboxyl bonds appeared as the temperature reached 300°C. The nitrogen incorporation functional group was found on the surface on the DND particles’ core, which could be removed after annealing treatment at 350°C.

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**TABLE I.** Parameters extracted from equivalent circuit

<table>
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<th>Sample</th>
<th>$C_p$ (pF)</th>
<th>$R_p$ (MΩ)</th>
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<tbody>
<tr>
<td>Untreated DND</td>
<td>13.1</td>
<td>7000</td>
</tr>
<tr>
<td>H-terminated (room temperature)</td>
<td>12.8</td>
<td>0.246</td>
</tr>
<tr>
<td>50°C</td>
<td>17.6</td>
<td>5.20</td>
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<tr>
<td>100°C</td>
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</tr>
<tr>
<td>350°C</td>
<td>22.7</td>
<td>246</td>
</tr>
<tr>
<td>400°C</td>
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<td>797</td>
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**TABLE II.** XPS analysis and content of impurities on DND

<table>
<thead>
<tr>
<th>Sample</th>
<th>N1s Content (at.%)</th>
<th>O1s Content (at.%)</th>
<th>C1s Content (at.%)</th>
<th>Cr2p Content (at.%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Untreated</td>
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<td>4.2</td>
<td>94.0</td>
<td>0.3</td>
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<td>H-terminated</td>
<td>2.6</td>
<td>1.6</td>
<td>95.5</td>
<td>0.3</td>
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<tr>
<td>50°C</td>
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<td>1.7</td>
<td>96.3</td>
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FIG. 1 SEM image of 4–6 nm 97% untreated nanodiamond (SIGMA-Aldrich Ltd.).

FIG. 2 Cross-section view of the testing cell structure.
FIG. 3 Impedance spectroscopy of (a) untreated DND; (b) H-terminated DND at room temperature; (c) H-DND annealed at 50°C and 100°C; (d) H-DND annealed at 150°C and 200°C; (e) H-DND annealed at 250°C and 300°C; (f) H-DND annealed at 350°C and 400°C.

FIG. 4 Equivalent circuit extracted from Cole-Cole plot before/after H-termination treatment.
FIG. 5 Arrhenius relationship of resistance $R_p$ extracted from the Cole-Cole plots.
FIG. 6 FTIR analysis of untreated DND, hydrogen-passivated DND and H-DND annealed from 50°C~400°C. All the DND powder was performed thermal treatment in air and then pressed into KBr pellets.

FIG. 7 XPS Survey spectra of untreated, H-terminated and 400°C annealed DND samples. The top of the significant C 1s peak has been cut off in order to highlight the other impurities.
Reference


